

| Ref # | Hits   | Search Query                                   | DBs   | Default Operator | Plurals | Time Stamp       |
|-------|--------|--|---|------------------|---------|------------------|
| L1    | 379479 | ("438"/\$.ccls. or "257"/\$.ccls.)             | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 10:55 |
| L2    | 70     | 1 and (imprint\$3 near10 polymer)              | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:38 |
| L3    | 1      | 2 and (bond near5 pad) and (solder near5 bump) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:47 |
| L4    | 115    | 1 and (imprint\$3 same polymer)                | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:46 |
| L5    | 3      | 4 and (bond near5 pad) and (solder near5 bump) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:38 |
| L6    | 644    | 1 and (passivation near10 polymer)             | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:47 |
| L7    | 75     | 6 and (bond near5 pad) and (solder near5 bump) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:47 |
| L8    | 17     | 7 and (cur\$3 near5 (polymer or passivation))  | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/02/22 11:48 |

|    |    |  |   |    |    |                  |
|----|----|--|---|----|----|------------------|
| L9 | 16 | 8 and ((imprint\$ or pattern\$3)<br>same (polymer or passivation)) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2005/02/22 11:48 |
|----|----|--|---|----|----|------------------|